



Model 1190100-XXX

20 MHz, Stratum 3E OCXO

Features

- Industry standard 25.4 x 22 mm SMT package
- Stratum 3E per GR-1244-Core and CR-253-Core
- 3.3V or 5.0V operation
- Low Phase Noise
- Tape and Reel packaging

Applications

- Telecom Switching
- Wireless Communication
- Timing over Packet



25.4 x 22 x 12 mm

Description

The CTS model 1190100 is a low cost, small size, high performance OCXO. The high quality CTS Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system

Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
Operating Conditions					
Operating Temperature Range		-40	-	+85	°C
Supply Voltage	3.3V	3.135	3.3	3.465	Vdc
	5.0V	4.75	5.0	5.25	
Power Consumption	Warm up	-	-	2.5	W
	Steady state @ 25°C	-	-	1.2	
Load	Output to Ground	5	10	15	pf
Frequency Stability					
Frequency	F_{NOM}		20.000		MHz
Calibration	$\Delta F/F_{NOM}$ at time of shipment	-	±75	+200	ppb
Temperature Stability	See options table	-	7	10	ppb pk-pk
Voltage Stability	±5%	-	±1	±3	ppb
	Per day, at time of shipment	-	±0.5	±1	ppb/day
Aging	First year	-	-	±100	ppb
	10 years	-	-	±700	ppb
Holdover (24 hours)	Inclusive of operating temp and 24 hours aging drift – See Table 1	-	-	11	ppb pk-pk

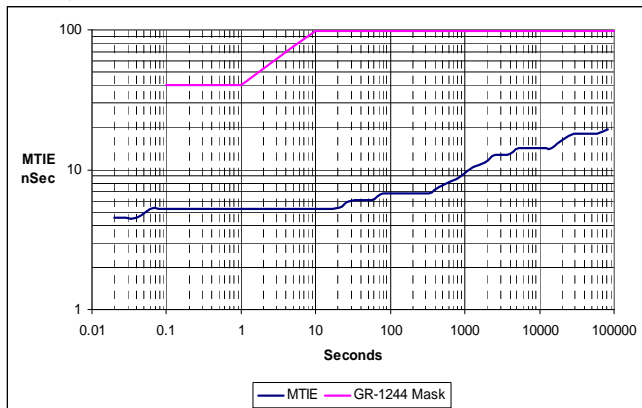
Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
Operating Conditions Continued					
Total Free-Run Accuracy	Under all conditions for 10 years	-	-	±2.5	ppm
Drift	24 hours at constant temperature – See Table 1	-	-	±1	ppb
Short Term Stability ADEV (in still air)	1.0 sec	-	<0.01	0.02	ppb
	10 sec	-	0.01	0.03	
	100 sec	-	0.02	0.05	
	1000 sec	-	0.05	0.1	
	10,000 sec	-	0.07	0.2	
Wander Generation	MTIE and TDEV per Stratum 3E requirements per GR-1244-CORE and GR-253-CORE				
Warm-Up Time	T _A = 25°C; to within 50 ppb of frequency @ 30 minutes	-	-	5	minutes

Output Parameters – HCMOS

Amplitude	V _{OL}	-	-	10% V _{CC}	V
	V _{OH}	90% V _{CC}	-	-	
Rise / Fall Times	10% to 90% @ 10pf load	-	-	8	nsec
Duty Cycle	@ 50% of output signal	45	-	55	%
Spurious		-	-	-70	dBc
Phase Noise	Offset = 10Hz	-	-115	-110	dBc/Hz
	100Hz	-	-140	-135	
	1KHz	-	-150	-145	
	10KHz	-	-155	-150	

Typical Wander Generation MTIE performance



Typical Wander Generation TDEV performance

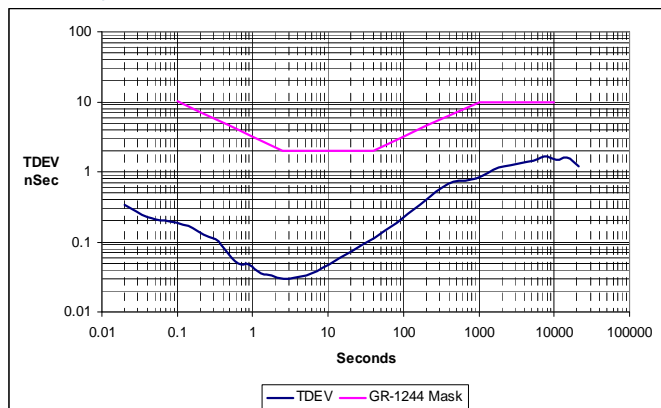


Table 1 – Aging Recovery

Time Off	Minimum power on time to recover daily aging rate
≤ 1 day	24 hours
< 1 week	3 days
< 1 month	6 days

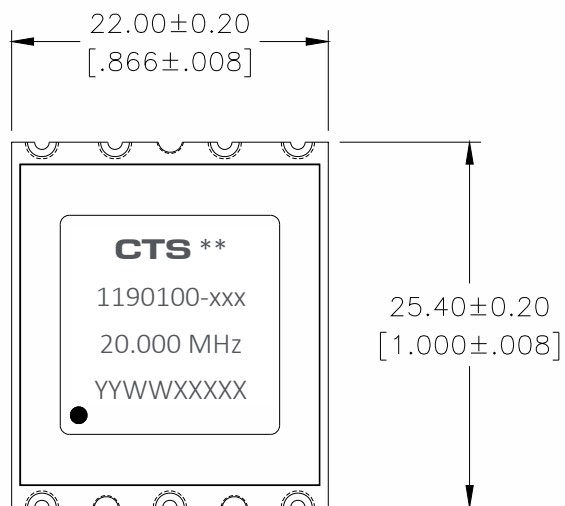
Options and Part Number

Dash No.	Supply voltage	Operating Temp. Range	Part Number
-001	+5.0 Vdc	-20°C to +70°C	1190100-001
-002	+5.0 Vdc	-40°C to +85°C	1190100-002
-003	+3.3 Vdc	-20°C to +70°C	1190100-003
-004	+3.3 Vdc	-40°C to +85°C	1190100-004

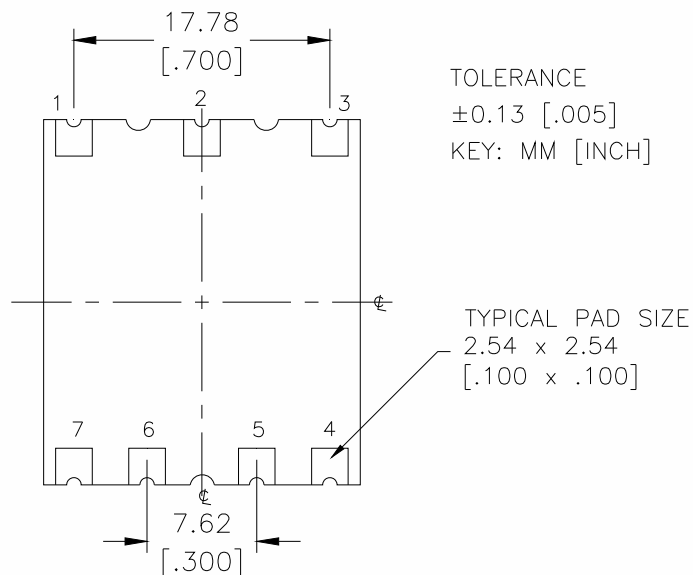
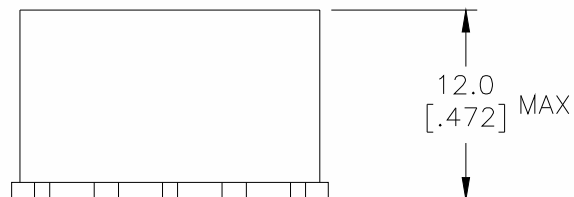
Mechanical and Environmental

Soldering	Maximum reflow temperature, 245°C for 10 seconds, 240°C for 20 seconds, per IPC/JEDEC J-STD-020C
MSL	Level 1
RoHS	Lead-Free. Fully compliant to RoHS Directive 2011/65/EU
Shock	500 G's, 1msec, 5 shocks in each of 6 directions
Sinusoidal Vibration	10 Hz to 55 Hz with a double amplitude of 1.5 mm, 10 g's peak from 55 Hz to 2000Hz, for 30 minutes in each of three perpendicular directions
Random Vibration	5.35 G's RMS. 20 to 500 Hz, per MIL-STD-202F, Method 214, 15 minutes each axis.
Seal	Non hermetic
Marking Permanency	Per MIL-STD-202F, Method 215J
Attachment Method	SMT
Storage Temp Range	-40 to +85°C

Mechanical Specifications



PIN 1 IDENTIFIER



Product Marking

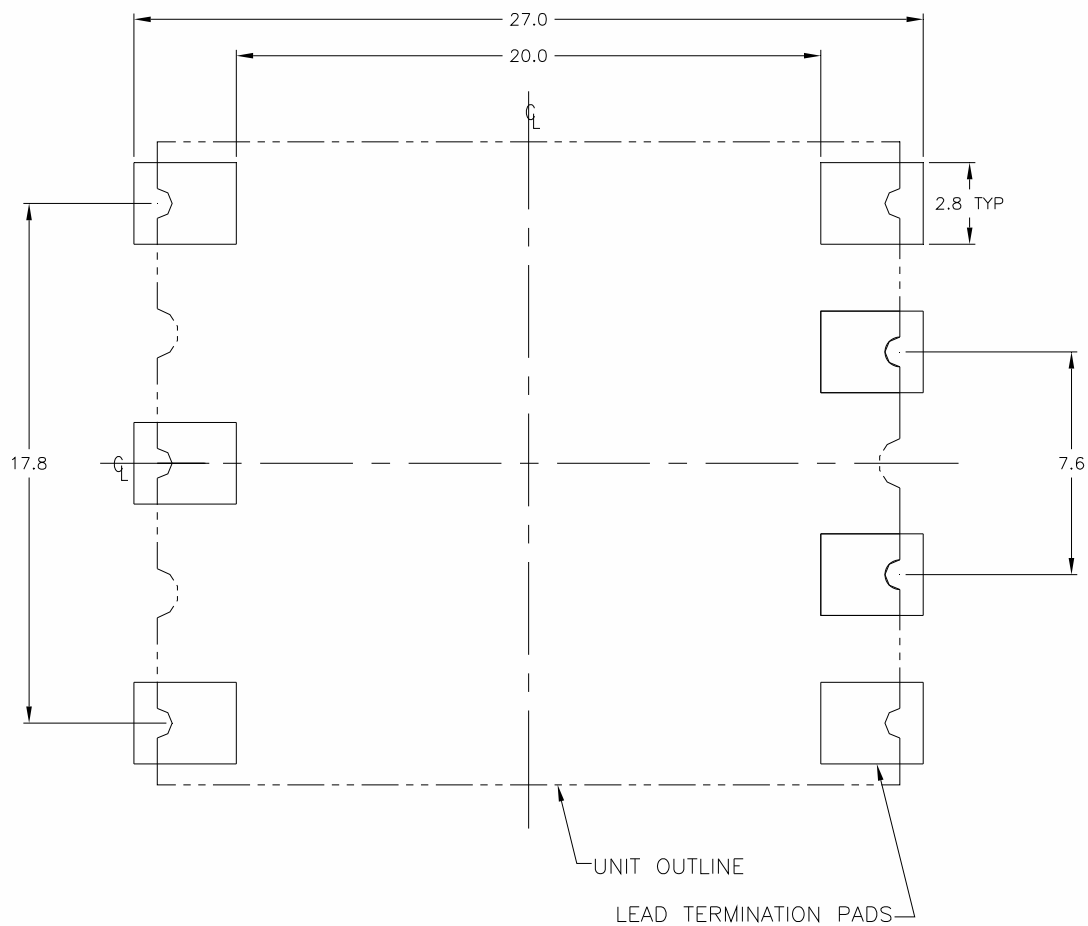
**	Mfg Site Code
-xxx	P/N option
YYWWXXXXX	DC/Serial Number

Pin No. Pin Function

1	NC
2	NC
3	V _{CC}
4	Output
5	NC
6	NC
7	Ground

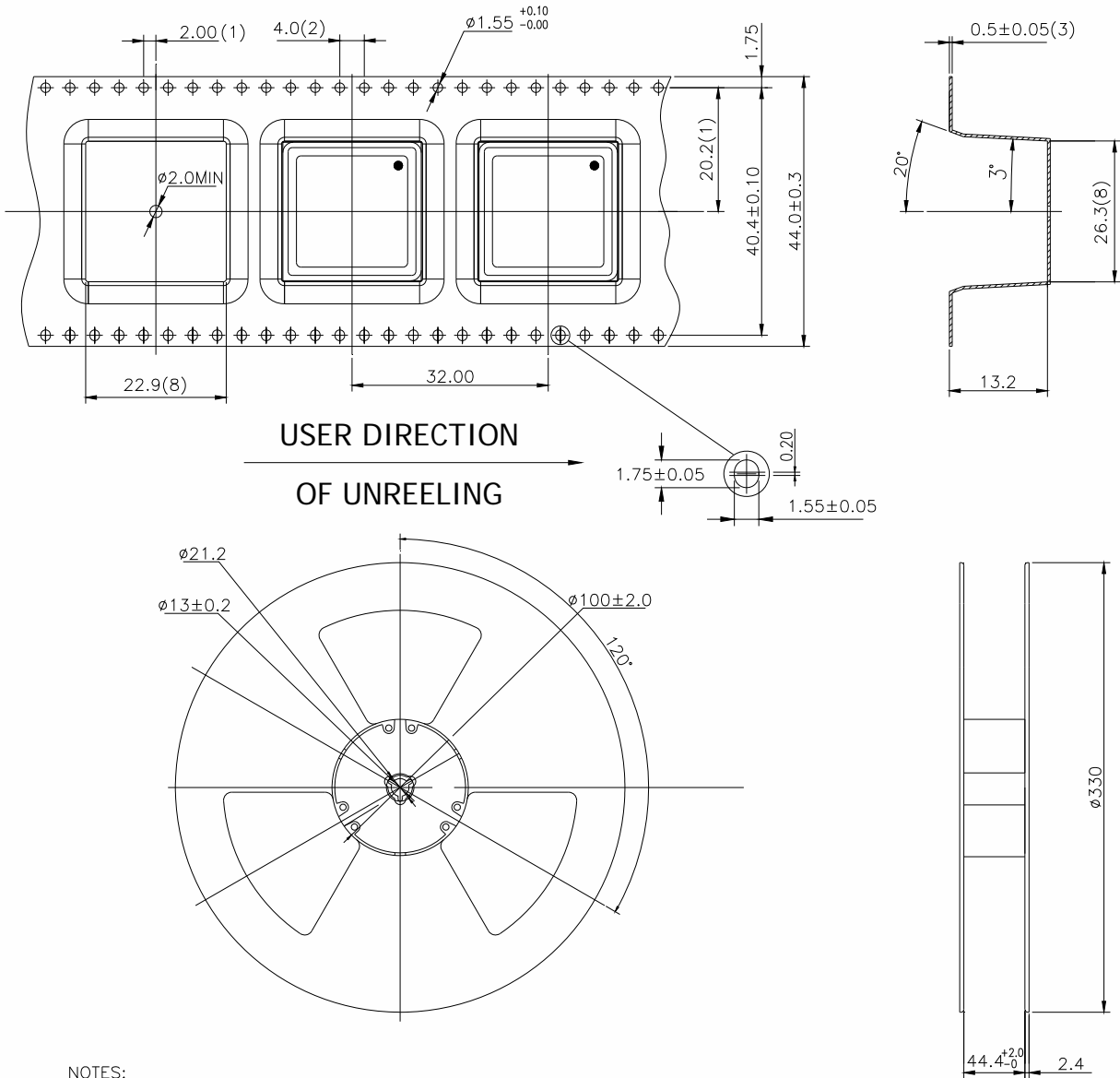
Pad termination finish: Gold Flash <10 micro inch, over Ni plated Cu

Recommended Land Pattern



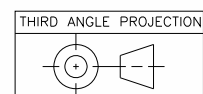
RECOMMENDED LAND PATTERN

Packing: Tape and Reel

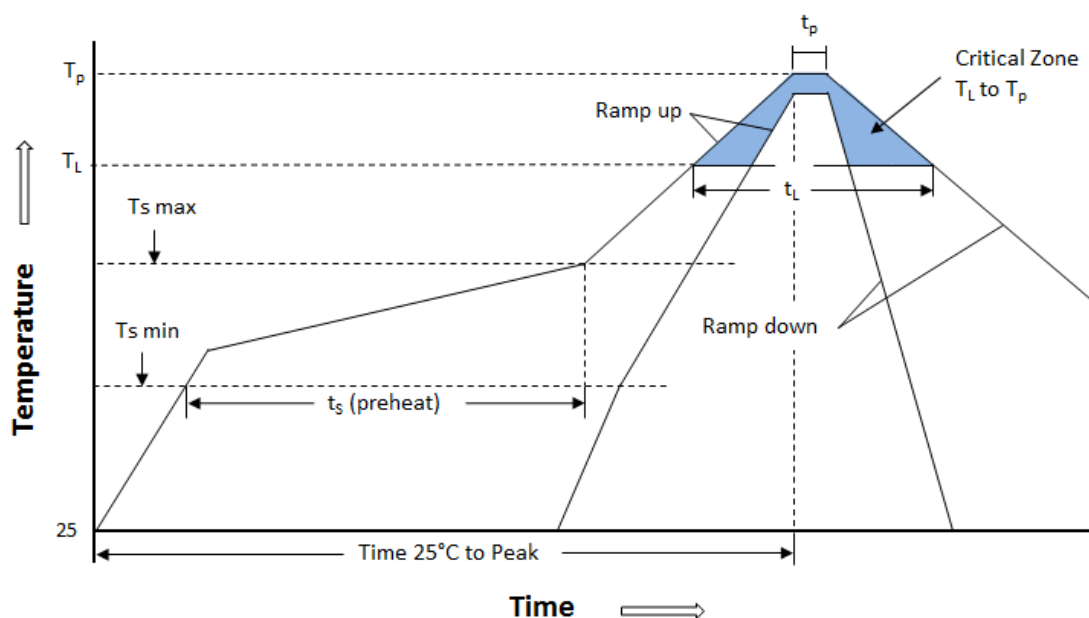


NOTES:

1. MEASURED FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET HOLE AND FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET
2. CUMULATIVE TOLERANCE OF 10 SPROCKET HOLES IS ± 0.20
3. THIS THICKNESS IS APPLICABLE AS MEASURED AT THE EDGE OF THE TAPE
4. MATERIAL: BLACK POLYSTYRENE
5. DIM IN MM
6. ALLOWABLE CAMBER TO BE 1mm PER 100mm IN LENGTH, NON-CUMULATIVE OVER 250mm
7. UNLESS OTHERWISE SPECIFIED, TOLERANCE ± 0.10
8. MEASUREMENT POINT TO BE 0.3 ABOVE THE INDICATED POINT.
9. SURFACE RESISTIVITY: FROM 10^5 TO 10^8 OHMS/SQ
10. MAXIMUM QUANTITY 50 UNITS IN ONE TAPE&REEL
11. UNITS: MM



Reflow profile per IPC/JEDEC J-STD-020C



Note: The temperatures shown below represent the device body temperature

Ts max to T_L (Ramp-up Rate)	3°C/second max
Preheat	
Temperature Min($T_s \text{ Min}$)	150°C
Temperature Typical($T_s \text{ Typ}$)	175°C
Temperature Max.($T_s \text{ Max}$)	200°C
Time(t_s)	60-180 seconds
Ram-up Rate(T_L to T_p)	3°C/second max
Time Maintained Above:	
--Temperature(T_L)	217°C
--Time(T_L)	60-150seconds
Peak Temperature (T_p)	245°C max for 10 seconds
Time within 5°C of actual peak(t_p)	20 seconds
Ramp-down Rate	6°C/second max
Tune 25°C to Peak Temperature(t)	8 minutes max